

Final Product/Process Change Notification Document #:FPCN22724X Issue Date:11 Oct 2019

Title of Change:	PQ DFN8 drivers capacity expansion in OSPI Tarlac turnkey enablement			
Proposed First Ship date:	15 Feb 2020 or earlier if approved by customer			
Contact Information:	Contact your local ON S	act your local ON Semiconductor Sales Office or Elmer.Milar@onsemi.com		
PCN Samples Contact:	Contact your local ON Semiconductor Sales Office or <pcn.samples@onsemi.com>. Sample requests are to be submitted no later than 30 days from the date of first notification, Initial PCN or Final PCN, for this change. Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements.</pcn.samples@onsemi.com>			
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or Andy.Esteva@onsemi.com			
Type of Notification:	This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 90 days prior to implementation of the change. ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact PCN.Support@onsemi.com			
Marking of Parts/ Traceability of Change:	Products assembled in OSPI Tarlac will have a Month Code marking of "M "			
Change Category:	Assembly Change, Test Change			
Change Sub-Category(s):	Manufacturing Site Change/Addition			
Sites Affected:				
ON Semiconductor Sites		External Foundry/Subcon Sites		
ON Semiconductor Tarlac, Philippines		None		

Description and Purpose:

Facility	Before Change Description	After Change Description	
Assembly Site	UTAC (TH3) Thailand Seremban SBN Mold Compound = MC G700LTD	UTAC (TH3) Thailand Seremban (SBN) OSPI Tarlac (PHM) All Assembly BOMs are going to be the same except for the Mold Compound. Mold Compound (Tarlac) = MC G770 HMD	
Test Site	UTAC (TH6) Thailand Seremban SBN	UTAC (TH6) Thailand Seremban (SBN) OSPI Tarlac (PHM)	

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Reliability Data Summary:

QV DEVICE NAME: NCP81258MNTBG

RMS : 57784

PACKAGE : DFN8 2*2*0.9

Test	Specification	Condition	Interval	Results
HTOL	JESD22-A108	Ta=125°C, 100 % max rated Vcc 13.2V	1008 hrs	0/240
HTSL	JESD22-A103	Ta= 150°C	1008 hrs	0/240
TC	JESD22-A104	Ta= -65°C to +150°C	1000 cyc	0/240
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias 13.2V	192 hrs	0/240
uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/240
PC J-STD-020	J-STD-020 JESD-A113	MSL 1 @ 260 °C		
	J-51D-020 JESD-A113	3 IR @ 260 deg C	=	
RSH	J-STD-002	Ta=265C, 10 sec	-	0/45
SD	J-STD-002or JESD22 B102	Ta=245C		0/45
PD	JESD22 B100,B108	Applicable POD/Case Outline		0/30

Electrical Characteristics Summary:

Electrical characteristics are not impacted.

List of Affected Parts:

Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the <u>PCN Customized Portal</u>.

Part Number	Qualification Vehicle		
NCP81166MNTBG	NCP81258		
NCP81166HMNTBG	NCP81258		
NCP81161MNTBG	NCP81258		
NCP81151MNTBG	NCP81258		
NCP81151FHMNTBG	NCP81258		
NCP81151FDMNTBG	NCP81258		
NCP81151BMNTBG	NCP81258		
NCP5901MNTBG	NCP81258		
NCP5901BMNTBG	NCP81258		
NCP81258MNTBG	NCP81258		
NCP81258HMNTBG	NCP81258		
NCP81258FHMNTBG	NCP81258		
NCP81258FDMNTBG	NCP81258		

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Appendix A: Changed Products

D

Product	Customer Part Number	Qualification Vehicle	New Part Number	Replacement Supplier
NCP81161MNTBG		NCP81258		
NCP81151MNTBG		NCP81258		
NCP81151BMNTBG		NCP81258		
NCP5901MNTBG		NCP81258		
NCP5901BMNTBG		NCP81258		